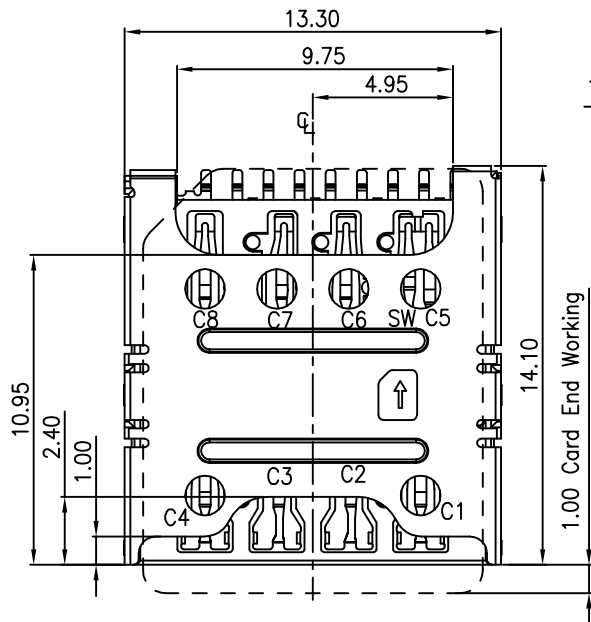
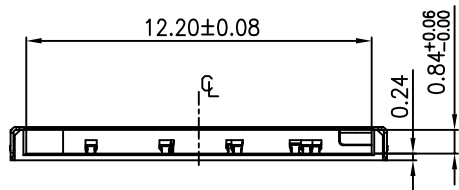
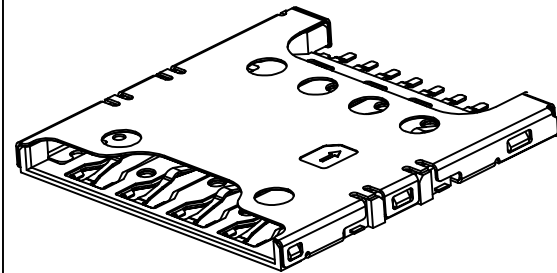
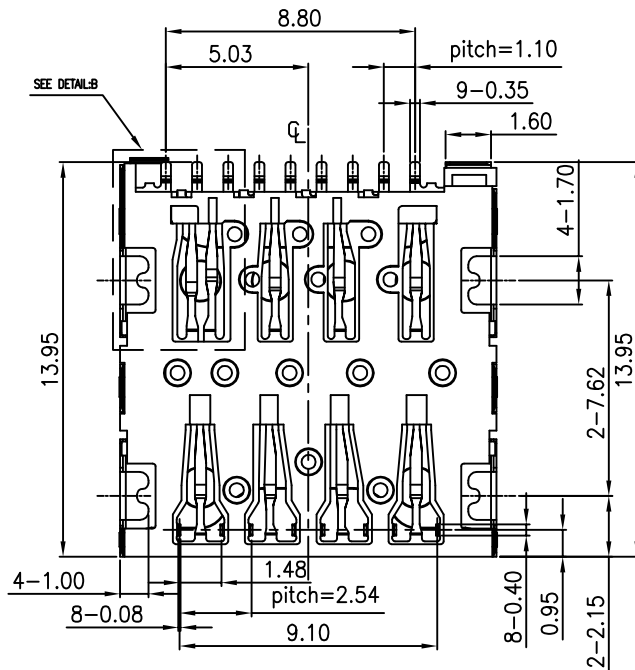


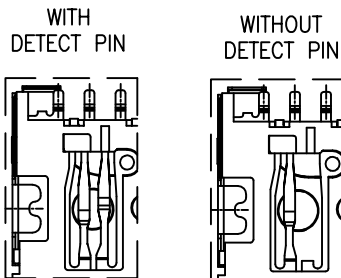
REV.	ECN.NO.	MODIFY.CONTENT	DATE
A		NEW	2015/03/29



1.18^{+0.08}_{-0.05}



0.10
ALL SOLDER TAILS AND SOLDERINGS



DETAIL: B
SCALE:1:1

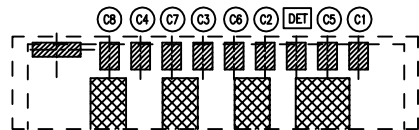
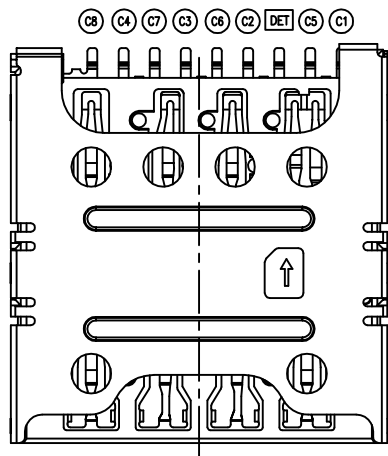
NOTES:

- MATERIAL:
 - Housing:High Temperature Thermoplastic UL94V-0; Color Black.
 - Terminal:Copper Alloy.
 - Shell:Stainless Steel.
- SPECIALITY:
 - Rated current:1.0A
 - Rated voltage:30V
 - Contact Resistance:50mΩ MAX
 - Insulation Resistance:1000MΩ MIN 500V DC
 - Dielectric withstanding voltage: 500V AC.
 - Solder ability:255±5°C, 5±0.5s.
 - Durability:3000 Cycles Min.
 - Operating condition:Temperature-40°C~+85°C; Humidity 80% R.H MAX

PART No:	DESCRIPTION
JYS-SIM118-123	WITHOUT DETECT PIN
JYS-SIM118-124	WITH DETECT PIN

GENERAL TOLERANCE		DWG NO.	JYSA0422-001	APPD:	WIND	Scale	1:1
X.±0.45	x.'±5'	Title	MICRO SIM H1.18mm CONNECTOR	CHKD:		UNIT	mm
.X±0.35	.x'±2'			DR:			
.XX±0.25	.xx'±1'	Part No.	SEE TABLE	Date	2015/03/29		
.XXX±0.15	.xxx'±0.5'						
SHEET	1/1	杰宇森电子有限公司 JIE YU SEN ELECTRONIC CO., LTD.					

REV.	ECN.NO.	MODIFY.CONTENT	DATE
A		NEW	2015/03/29



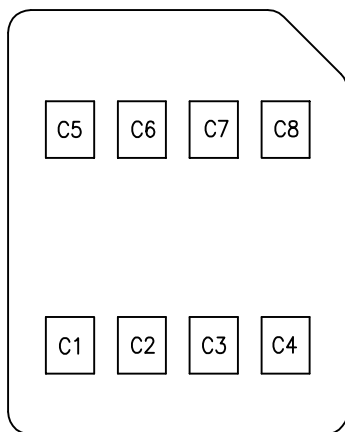
DETAIL:A
SCALE:1:1

SW CIRCUIT DESCRIPTION FOR MICRO SIM:

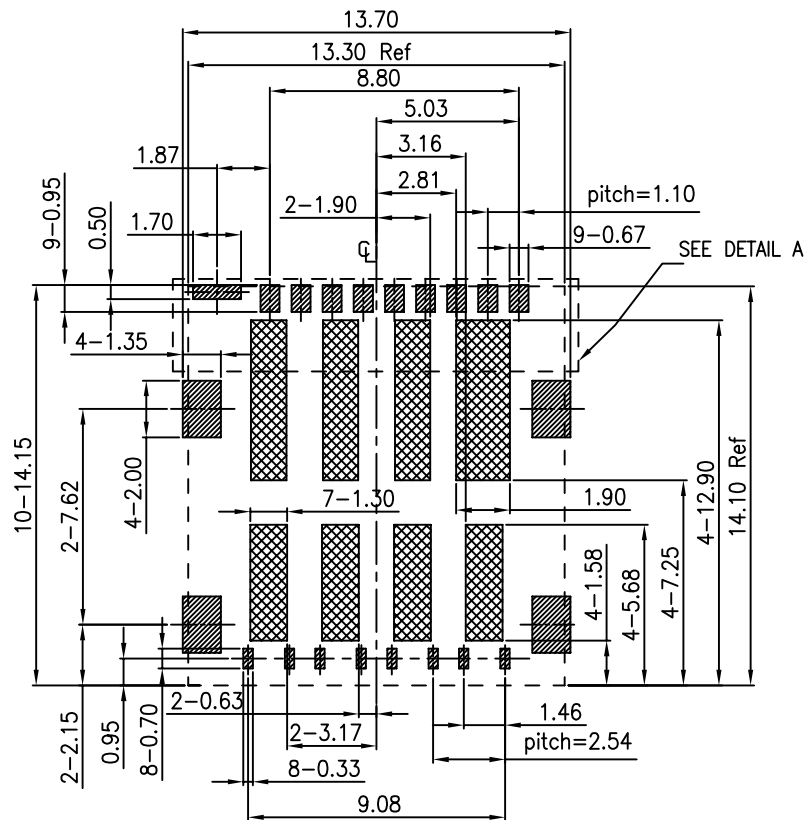
CARD INSERTION STATE	SCHEMATIC
INSERT CARD	DETECT PIN [SW] — C5
EXTRACT CARD	DETECT PIN [SW] — C5

Circuit Description:

PIN No.	FUNCTION
C1	VCC
C2	RST
C3	CLK
C4	RESERVED
C5	GND
C6	VPP
C7	I/O
C8	RESERVED



MICRO SIM CARD



RECOMMENDED PCB LAYOUT TOP VIEW
(TOLERANCE:±0.05)

- THESE AREA SHOULD BE FREE OF ANY CONDUCTIVE TRACES.
- SMT SOLDER AREA.

GENERAL TOLERANCE		DWG NO.	JYSA0422-001	APPD:	WIND	Scale	1:1
X.±0.45	x.'±5'	Title	MICRO SIM H1.18mm CONNECTOR	CHKD:		UNIT	mm
.X±0.35	.x'±2'			DR:			
.XX±0.25	.xx'±1'	Part NO.	SEE TABLE	Date	2015/03/29		
.XXX±0.15	.xxx'±0.5'						
SHEET	1/1	杰宇森电子有限公司 JIE YU SEN ELECTRONIC CO., LTD.					